Nome: mini piattaforma riscaldante

Modello:VB-215A

Temp. Intervallo:  $160\sim250$ °C

N.W.: 90,4 g

Area di lavoro: 20 x 18,5 mm

Dimensioni del prodotto: 70,5x76,7x21,6 mm

Applicazione: adatto al 99% dei chip presenti sul mercato, universale per rimuovere colla e stagno

da vari tipi di iPhone, Huawei e altre CPU di telefoni cellulari



# Mini Heating Platform

160°C~250°C Adjustable

No need for heat gun or soldering iron heating, no need for soldering wick

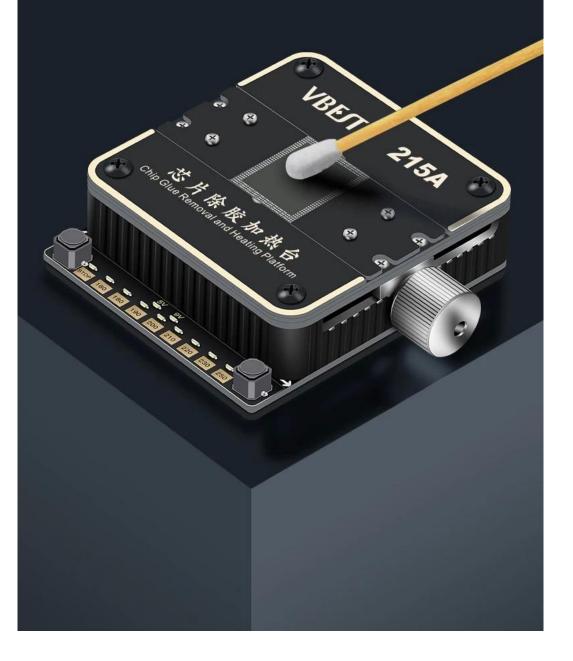
No damage to solder pads and paint



# No need for Soldering Wick



After heating to the set temperature, use a cotton swab to clean up the residual tin. No damage to the solder pad paint, no need for soldering wick wiping to wear out the chip

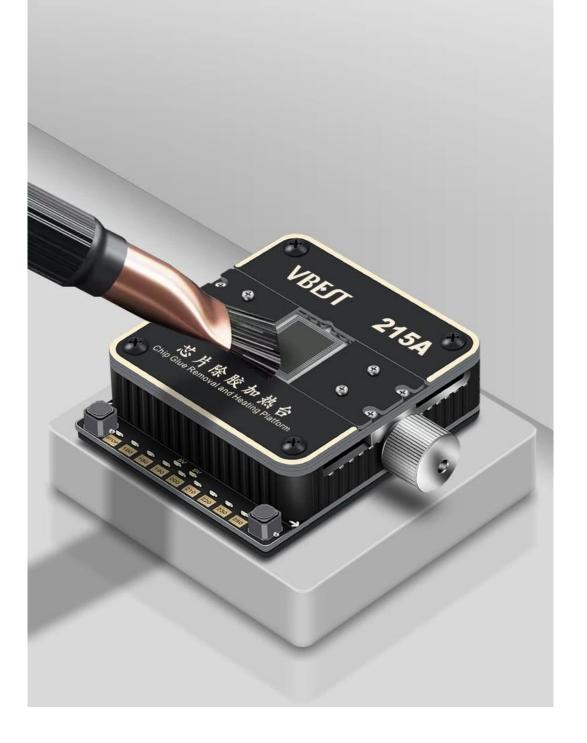


# **Heating to remove tin**



Turn on the heating platform and heating to the preset temperature, you can use a brush or cotton swab to remove residual tin without soldering wick.

Gently wipe to remove tin and glue easily.





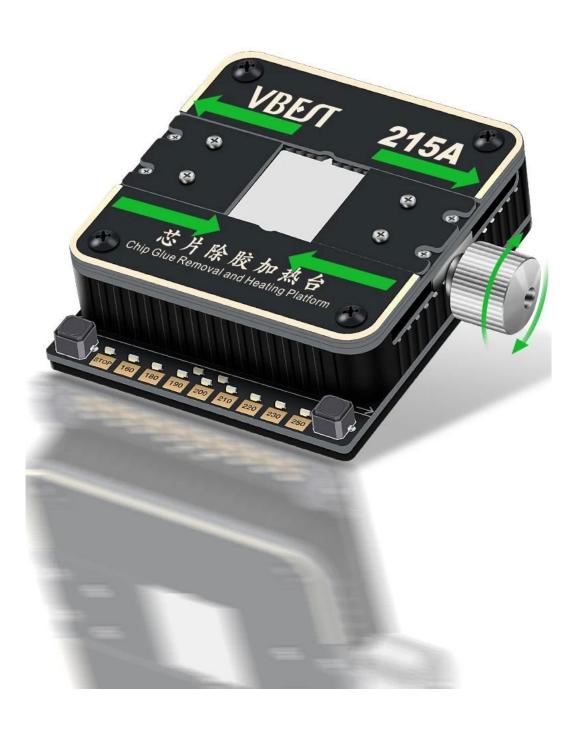
# **Low Voltage Heating Plate** Fast heating, no leakage, anti-static, safer heating Built in professional tuning curve, no need to worry about chip damage caused by thermal stress

### Flexible hidden screw rod



Hidden screw rod, flexible and clever, extendable and fixed clamping the chips

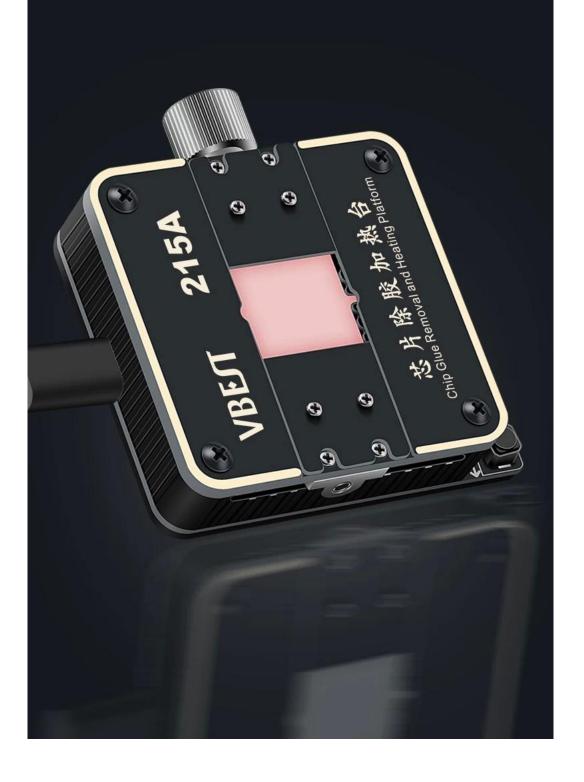
Prevent residue from falling into the screw, making it more durable



# **Uniform Heating**



No need for heat gun heating, it is safer to scrape glue at a temperature 100 °C lower than the heat gun No need to repeatedly scrape with a soldering iron, no damage to the solder pads

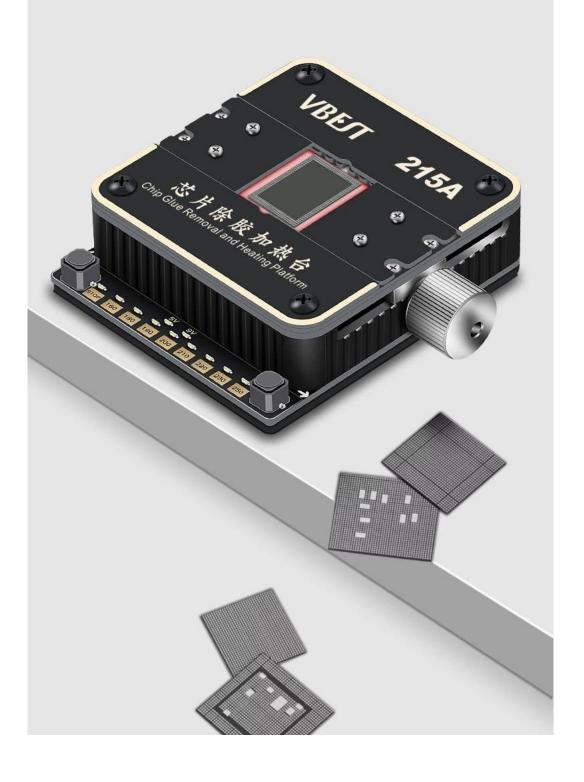




# Suitable for 99% of chips



Work area: 20mm×18.5mm (Max)
Support multi generation iPh, Huawei phone CPU chips and hard drives



# **Parameter**



Name Mini Heating Platfor	Model m VB-215A	Temp. Range 160~250℃
N. W.	Work area	Product Size
90.4g	20×18.5mm	70.5×76.7×21.6mm
Application		on the market, universal for m various types of iPhones, phone CPU

\* The above dimensions are measured manually and may have about 1-2mm error